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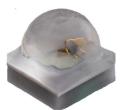


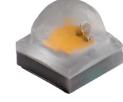
Cree® XLamp® XQ-A LEDs



PRODUCT DESCRIPTION

The XLamp[®] XQ-A LED brings a mid-power, cost-effective option to the proven, compact ceramic XQ package, enabling lighting manufacturers to quickly and easily expand their product portfolio by leveraging a common XQ design. Unlike plastic mid-power LEDs, the ceramic-based XQ-A LEDs are designed to deliver the long-term calculated lifetimes of Cree's other high-power LEDs. The XQ-A LED's combination of optical symmetry and consistency across all colors improves color mixing and simplifies the production process for lighting manufacturers. Available in both white and color configurations, the XQ-A LED family opens up new design possibilities for a wide spectrum of lighting applications, such as portable, directional, architectural and vehicle lighting.







FEATURES

- Cree's smallest lighting class LED: 1.6 X 1.6 mm
- Available in 70-, 80- & 90-CRI white, and royal blue, blue, green, PC amber, red-orange & red
- Maximum drive current: white: 300 mA, color: 250 mA
- Wide viewing angle: white: 100°, royal blue, blue, PC amber: 105°, green, red-orange, red: 110°
- Reflow solderable JEDEC
 J-STD-020C compatible
- Unlimited floor life at ≤ 30 °C/85% RH
- RoHS compliant
- UL[®] recognized component (E349212)

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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white	°C/W		20	
Thermal resistance, junction to solder point - royal blue, blue	°C/W		17	
Thermal resistance, junction to solder point - green	°C/W		30	
Thermal resistance, junction to solder point - PC amber	°C/W		20	
Thermal resistance, junction to solder point - red-orange, red	°C/W		18	
Viewing angle (FWHM) - white	degrees		100	
Viewing angle (FWHM) - royal blue, blue, PC amber	degrees		105	
Viewing angle (FWHM) - green, red-orange, red	degrees		110	
Temperature coefficient of voltage - white	mV/°C		-2.8	
Temperature coefficient of voltage - royal blue, blue	mV/°C		-4	
Temperature coefficient of voltage - green	mV/°C		-4.3	
Temperature coefficient of voltage - PC amber	mV/°C		-4.2	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2.0	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green, red-orange, red			Class 3A	
ESD classification (HBM per Mil-Std-883D) - PC amber			Class 2	
DC forward current-white	mA			300
DC forward current - color	mA			250
Reverse voltage	V			5
Forward voltage (@ 175 mA, 85 °C) - white	V		3.0	3.3
Forward voltage (@ 175 mA, 25 °C) - royal blue, blue	V		3.25	3.6
Forward voltage (@ 175 mA, 25 °C) - green	V		3.4	3.6
Forward voltage (@ 175 mA, 25 °C) - PC amber	V		3.4	3.7
Forward voltage (@ 175 mA, 25 °C) - red-orange, red	V		2.2	2.6
LED junction temperature	°C			150

FLUX CHARACTERISTICS - WHITE (T_J = 85 °C)

The following table provides several base order codes for XLamp XQ-A white LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XQ Family LEDs Binning and Labeling document.

Color	сст ғ	Range	Minimum	Luminous Flux	@ 175 mA	Calculated Minimum Luminous Flux (lm) @ 85 °C**	Order Code	
	Minimum	Maximum	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	300 mA		
			M3	45.7	52.6	65.6	XQAAWT-00-0000-00000L3E2	
Cool White	5000 K	8300 K	N2	51.7	59.5	74.2	XQAAWT-00-0000-00000L4E2	
			N3	56.8	65.3	81.6	XQAAWT-00-0000-00000L5E2	
70-CRI			M3	45.7	52.6	65.6	XQAAWT-00-0000-00000B3E2	
Minimum White	3700 K	8300 K	N2	51.7	59.5	74.2	XQAAWT-00-0000-00000B4E2	
white				N3	56.8	65.3	81.6	XQAAWT-00-0000-00000B5E2
Neutral	3700 K	5300 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000L2E4	
White	3700 K	5500 K	M3	45.7	52.6	65.6	XQAAWT-00-0000-00000L3E4	
Warm White	2700 K	3500 K	К3	35.2	40.5	50.5	XQAAWT-00-0000-00000LZE7	
Warm Winte	2700 K	3300 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000L2E7	
80-CRI Minimum	2700 K	3500 K	К3	35.2	40.5	50.5	XQAAWT-00-0000-00000HZE7	
White	2700 K	3500 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000H2E7	
90-CRI Minimum	2850 K	3000 K	J2	23.5	26.6	37.3	XQAAWT-00-0000-00000UYE7	
White	2000 1	3000 K	K2	30.6	35.2	43.9	XQAAWT-00-0000-00000UZE7	

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 15).
- Typical CRI for Cool White (5000 K 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- Minimum CRI for 70-CRI Minimum White is 70.
- Minimum CRI for 80-CRI Minimum White is 80.
- Minimum CRI for 90-CRI Minimum White is 90.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 350 mA are for reference only.

FLUX CHARACTERISTICS - COLOR (T_{J} = 25 °C)

The following table provides several base order codes for XLamp XQ-A color LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XQ Family LEDs Binning and Labeling document.

	Do	minant Wav	elength Rar	ıge	Minimum Dedien				
Color	Mini	mum	Maxi	mum	Minimum Radiant Flux @ 175 mA		Calculated Minimum PPF	Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)	(µ mol/s) *		
Devel Dive	D36 450 D57 465	450	0.57	7 445	11	210	0.80	XQAROY-00-0000-000000601	
Royal Blue D36 450		405	12	250	0.95	XQAROY-00-0000-000000701			

	Dominant Wavelength Range				Minimum Lumino				
Color	Mini	Minimim		mum	Minimum Luminous Flux @ 175 mA		Minimum Luminous Fiux @ 175 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)			
Dius	D2	465	Dć	405	F2	10.7	XQABLU-00-0000-000000T01		
ыце	Blue B3 465	B3 465 B6 485	G2	13.9	XQABLU-00-0000-00000000				

	Dor	ninant Wav	elength Rar	ige	Minimum Lumino	Minimum Luminous Elux @ 175 mA												
Color	Minimum Maximum		Minimum Luminous Flux @ 175 mA		Calculated Minimum PPF	Order Code												
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	(µmol/s)*											
			G4 535	G4	G4	G4	G4	G4		К2	30.6	0.28	XQAGRN-00-0000-000000Y01					
	00	500							G4	G4	G4	G4	G4	G4 535	КЗ	35.2	0.32	XQAGRN-00-0000-000000Z01
Green	G2	2 520 G4													535	M2	39.8	0.36
				M3	45.7	0.41	XQAGRN-00-0000-000000301											

Color Co	Color Bin	Minimum Lumino	us Flux @ 175 mA	Order Code	
Color		Group	Flux (lm)	order Code	
	Y2	J3	26.8	XQAAPA-00-0000-000000X01	
PC Amber		К2	30.6	XQAAPA-00-0000-000000Y01	
		КЗ	35.2	XQAAPA-00-0000-000000Z01	

Note

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and a tolerance of ±2 on CRI measurements. See the Measurements section (page 15).
- * Photosynthetic Photon Flux (PPF) values are calculated and for reference only.

FLUX CHARACTERISTICS - COLOR (T_J = 25 °C) - CONTINUED

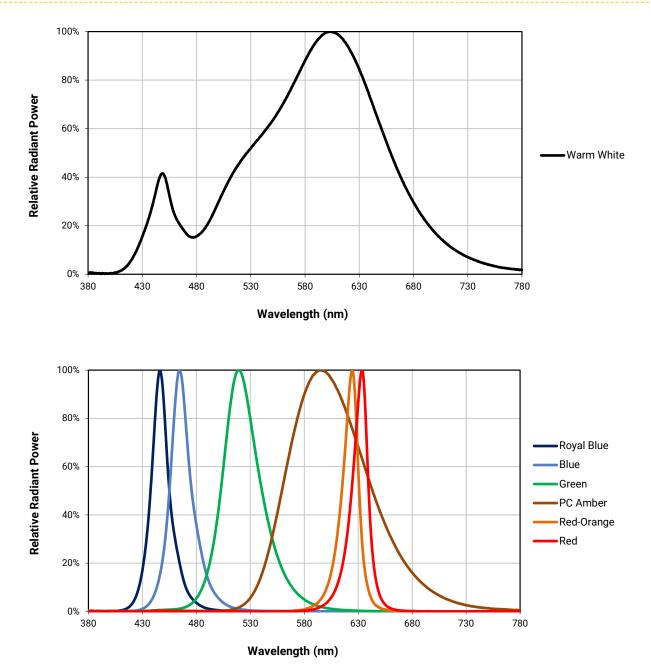
	Dor	ninant Wav	elength Ran	ge	Minimum Lumino	us Elux @ 17E mA						
Color	Minimum				us Flux @ 175 MA	Order Code						
	Group				Group	Flux (lm)						
						04		K2	30.6	XQARDO-00-0000-000000Y01		
Red-Orange	03	610	04	04	04		04	04	04	04 620	К3	35.2
					M2	39.8	XQARDO-00-0000-000000201					

	Dor	ninant Wav	elength Ran	ge		Mi-i					
Color	Minimum		Maxi	mum		Minimum Luminous Flux @ 175 mA		Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	(µ mol/s)*				
					R3	R3		J2	23.5	0.61	XQARED-00-0000-000000W01
Red	R2	620	R3	R3			R3	R3 630	J3	26.8	0.70
						К2	30.6	0.80	XQARED-00-0000-000000Y01		

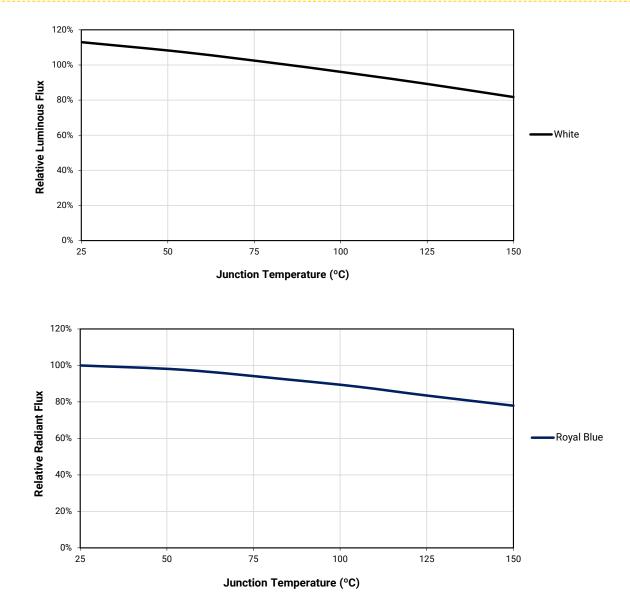
Note

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and a tolerance of ±2 on CRI measurements. See the Measurements section (page 15).
- * Photosynthetic Photon Flux (PPF) values are calculated and for reference only.

RELATIVE SPECTRAL POWER DISTRIBUTION

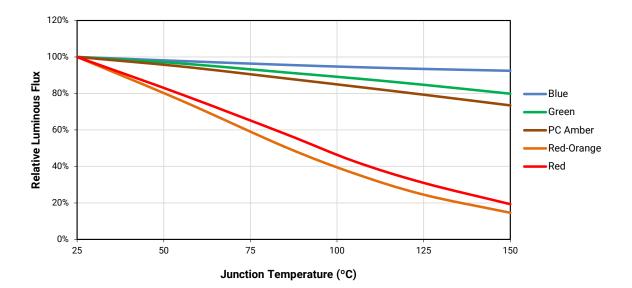


RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 175 \text{ mA}$)

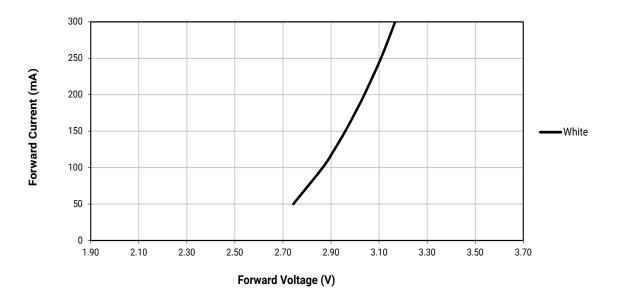




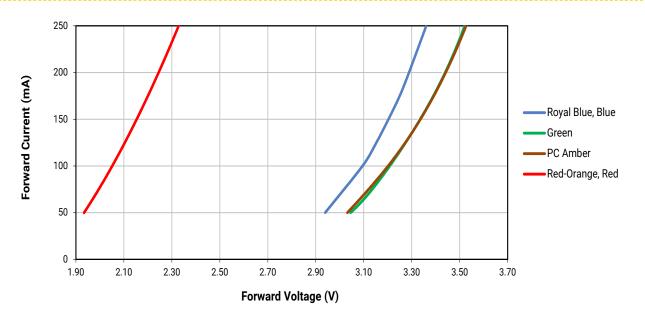
RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 175 \text{ mA}$) - CONTINUED



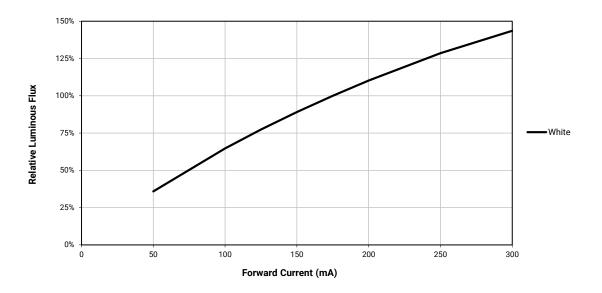
ELECTRICAL CHARACTERISTICS (T_J = 85 °C)



ELECTRICAL CHARACTERISTICS (T_J = 25 °C)

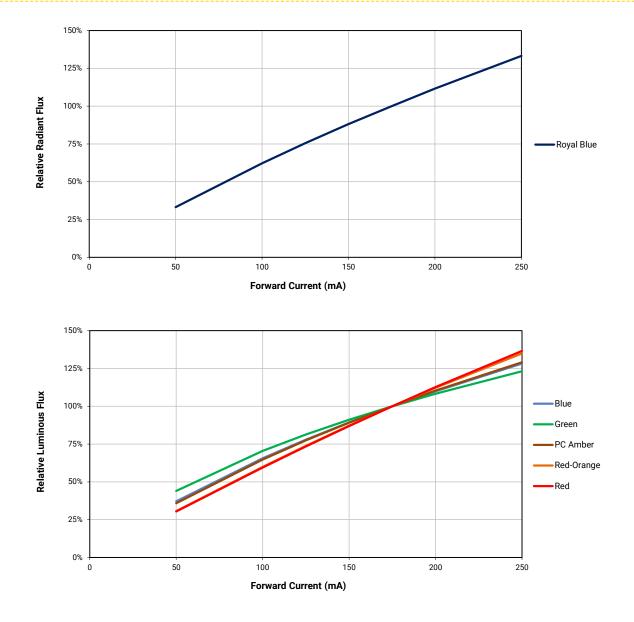


RELATIVE FLUX VS. CURRENT (T_J = 85 °C)



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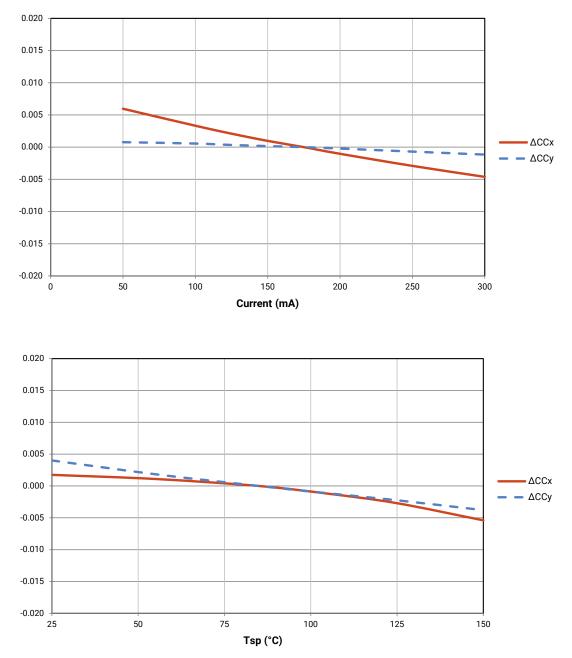
RELATIVE FLUX VS. CURRENT ($T_J = 25 °C$)



XLAMP[®] XQ-A LED

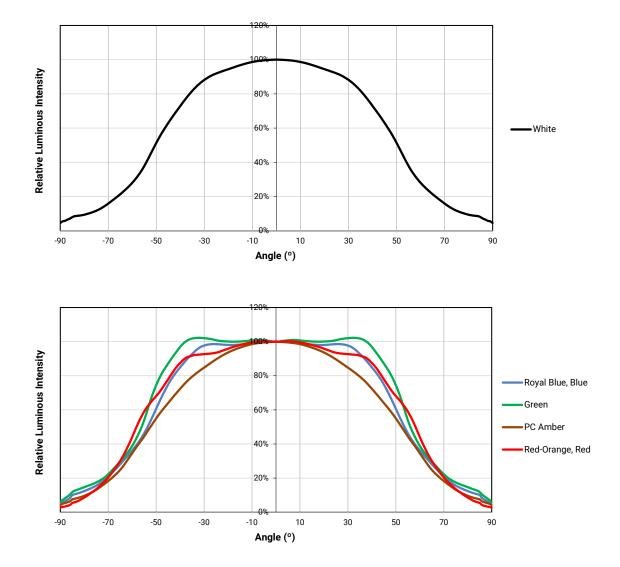






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TYPICAL SPATIAL DISTRIBUTION

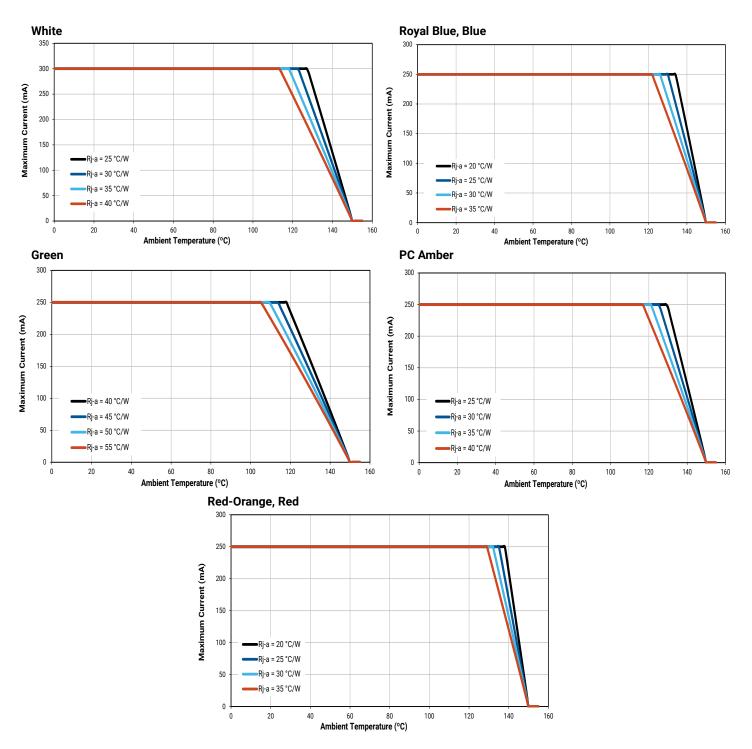


XLAMP[®] XQ-A LED



THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

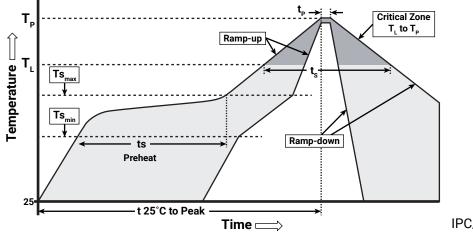


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REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XQ-A LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t_L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XQ-A LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Ecology section of the Cree website.

UL® Recognized Component

Level 1 enclosure consideration. The LED package or a portion thereof has not been investigated as a fire enclosure or a fire and electrical enclosure per ANSI/UL 8750.

Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

NOTES - CONTINUED

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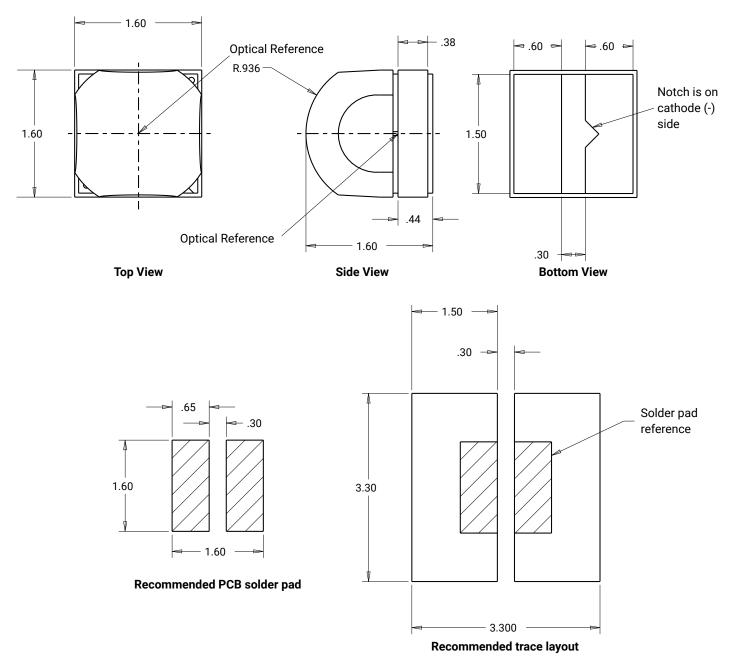
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MECHANICAL DIMENSIONS

Thermal vias, if present, are not shown on these drawings.

All dimensions in mm.

Measurement tolerances unless indicated otherwise: ±.13 mm

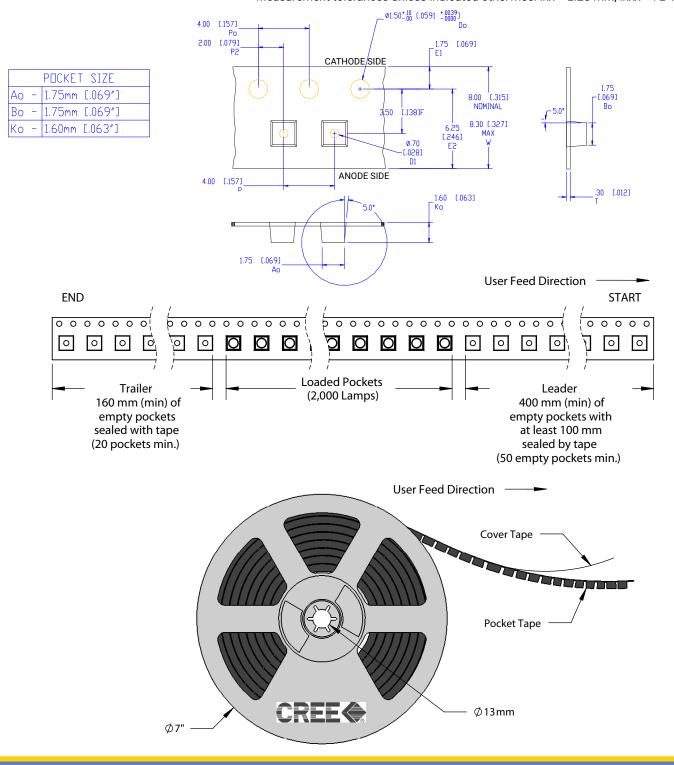


TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Except as noted, all dimensions in mm [in].

Measurement tolerances unless indicated otherwise: .xx = ±.25 mm, .xxx = . ± 125 mm



PACKAGING

The diagrams below show the packaging and labels Cree uses to ship XLamp XQ-A LEDs. XLamp XQ-A LEDs are shipped in tape loaded on a reel. Each box contains only one reel in a moisture barrier bag.

